#### PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT7513657

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
DENG SIONG LEE	01/20/2022
ROBIN YEW	01/13/2022
HAN SEONG CHEW	02/21/2022
TEONG HONG CHUAH	01/13/2022
SHANNON DAY	01/16/2022
CHRISTOPHER DANIEL PARKER	01/13/2022
VINAY MANJUNATH	01/13/2022
ALBERT JACK GREENWOOD WOFFENDEN	01/20/2022
CHUAN FOONG LEE	01/13/2022
MUHAMMAD ADIL BIN ABDUL HALIM	01/21/2022
ANDREW WILLIAM GILLETT	01/13/2022

#### **RECEIVING PARTY DATA**

Name:	RESMED ASIA PTE. LTD.
Street Address:	3 TUAS AVENUE 2
City:	SINGAPORE
State/Country:	SINGAPORE
Postal Code:	639443
Name:	RESMED PTY LTD
Street Address:	1 ELIZABETH MACARTHUR DRIVE
City:	BELLA VISTA, NEW SOUTH WALES
State/Country:	AUSTRALIA

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17550168

#### **CORRESPONDENCE DATA**

Fax Number: (703)816-4100

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Correspondent Name: PAUL T. BOWEN/NIXON & VANDERHYE P.C.

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ATTORNEY DOCKET NUMBER:	PTB-4398-2389
NAME OF SUBMITTER:	PAUL T. BOWEN
SIGNATURE:	/Paul T. Bowen/
DATE SIGNED:	08/31/2022

#### **Total Attachments: 65**

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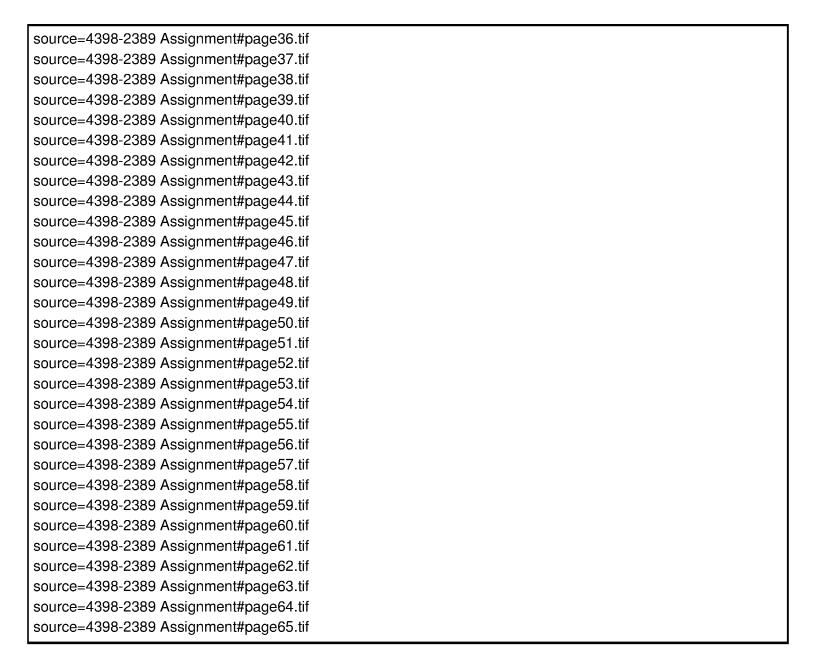
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# CONFIRMATION OF ASSIGNMENT Inventor(s) to ResMed Asia Pte. Ltd. And ResMed Pty Ltd

WHEREAS, I/we, Deng Siong Lee, Robin Yew, Han Seong Chew, Teong Hong Chuah, Shannon Day, Christopher Daniel Parker, Vinay Manjunath, Nigel Paul Greig, Albert Jack Greenwood Woffenden, Chuan Foong Lee, Muhammad Adil Bin Abdul Halim, and Andrew William Gillett, an inventor, joint inventor, inventors or joint inventors (collectively hereinafter "Inventor") have made certain new and useful inventions relating to [ORO-PILLOW CUSHION ASSEMBLY], (hereinafter "Inventive-Subject matter") which is described in and for which application has been made as follows:

 U.S. Utility Application filed on December 14, 2021 and designated as Application No. 17/550,168.

WHEREAS, ResMed Asia Pte. Ltd., a company incorporated in Singapore, and ResMed Pty Ltd, a company incorporated in Australia (hereinafter "Assignees"), whose postal address is 3 Tuas Avenue 2 Singapore 639443, and 1 Elizabeth Macarthur Drive, Bella Vista, New South Wales, Australia 2153, respectfully, is desirous of acquiring the entire right, title and interest in and to said Inventive Subject-Matter, including without limitation said application(s), for every jurisdiction, including without limitation the United States of America and all other countries, and any benefits of or to be obtained therefrom:

NOW THEREFORE, in consideration of the sum of one dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, and on the Effective Date herein, Inventor has sold, assigned, and set over and/or to any extent not previously, by these presents does hereby sell, assign and set over unto Assignee and Assignee's legal representatives, successors and assigns, Inventor's entire right, title and interest in and to said Inventive Subject-Matter for every jurisdiction, including without limitation the United States of America and all other countries, said application(s) and any benefits of or to be obtained therefrom, including without limitation any continuation, including continuation-in-part, or divisional application, renewal or substitute thereof, international, foreign and regional applications corresponding or claiming priority thereto pursuant to any law or treaty, including the right to claim such priority or benefit, and the Letters Patent, both foreign and domestic, that may or shall issue thereon, or any reissue or re-examination thereof, and Inventor does hereby authorize and request the U.S. Commissioner of Patents and any other country's

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Commissioner of Patents to issue said Letters Patent to the above-mentioned Assignee, consistent with the terms of this Assignment.

UPON SAID CONSIDERATION, Inventor hereby covenants and agrees with Assignee that Inventor has not and will not execute any writing or do any act whatsoever conflicting with these presents, and that Inventor will, at any time upon request, without further or additional consideration, but at the expense of Assignee, execute such additional assignments and other writings and do such additional acts as Assignee may deem necessary or desirable to perfect Assignee's or Assignee's assign's enjoyment of this grant, and render all necessary assistance in making application for and obtaining original, continuation, including continuation-in-part, or divisional application, renewal, substitute, reissued, re-examined or extended Letters Patent of the United States, or of any and all other countries, on said Inventive Subject-Matter, and in enforcing any rights or chose in action accruing as a result of such applications or patents, by giving testimony in any proceedings or transactions involving such applications or patents, and by executing preliminary statements and other affidavits, it being understood that the foregoing covenant and agreement shall bind, and inure to the benefit of, the assigns and legal representatives of all parties.

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**EFFECTIVE DATE: DECEMBER 14, 2021** 

IN WITNESS WHEREOF, we have hereunto set our hands on the date indicated below.

DocuSigned by:

DCF9ED22993A4F2..

Deng Siong LEE

Address: c/o ResMed Asia Pte.

Ltd., 3 Tuas Avenue 2 Singapore 639443

1 Veng Siong LEE 1

20-Jan-2022

**Date Signed** 

## **Robin YEW** Address: c/o ResMed Asia Pte. **Date Signed** Ltd., 3 Tuas Avenue 2 Singapore 639443 **Han Seong CHEW** Address: c/o ResMed Asia Pte. **Date Signed** Ltd., 3 Tuas Avenue 2 Singapore 639443 Teong Hong CHUAH **Date Signed** Address: c/o ResMed Asia Pte. Ltd. 3 Tuas Avenue 2 Singapore 639443 **Date Signed Shannon DAY** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 **Christopher Daniel PARKER Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153

### **Vinay MANJUNATH Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 Nigel Paul GREIG **Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 **Albert Jack Greenwood WOFFENDEN Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 **Date Signed Chuan Foong LEE** Address: c/o ResMed Asia Pte. Ltd. 3 Tuas Avenue 2 Singapore 639443 Muhammad Adil BIN ABDUL HALIM **Date Signed** Address: 25 Canberra Drive, #04-52 Singapore 768078 **Andrew William GILLETT Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales

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Australia 2153

Executed for and on behalf of ResMed Asia Pte. Ltd.
Signature of Authorised Person
Chin Wee Chew Name of Authorised Person
Singapore Office held
Date:
Executed for and on behalf of ResMed Pty Ltd
Signature of Authorised Person
Robert Zalud Name of Authorised Person
Australia Office held

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**EFFECTIVE DATE: DECEMBER 14, 2021** 

IN WITNESS WHEREOF, we have hereunto set our hands on the date indicated below.

**Deng Siong LEE**Address: c/o ResMed Asia Pte.
Ltd., 3 Tuas Avenue 2
Singapore 639443

Date Signed

DocuSigned by:

13-Jan-2022 **Robin YEW** Address: c/o ResMed Asia Pte. **Date Signed** Ltd., 3 Tuas Avenue 2 Singapore 639443 **Han Seong CHEW** Address: c/o ResMed Asia Pte. **Date Signed** Ltd., 3 Tuas Avenue 2 Singapore 639443 Teong Hong CHUAH **Date Signed** Address: c/o ResMed Asia Pte. Ltd. 3 Tuas Avenue 2 Singapore 639443 **Shannon DAY Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 **Christopher Daniel PARKER Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive

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Australia 2153

Bella Vista, New South Wales

### **Vinay MANJUNATH Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 Nigel Paul GREIG **Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 **Albert Jack Greenwood WOFFENDEN Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 **Date Signed Chuan Foong LEE** Address: c/o ResMed Asia Pte. Ltd. 3 Tuas Avenue 2 Singapore 639443 Muhammad Adil BIN ABDUL HALIM **Date Signed** Address: 25 Canberra Drive, #04-52 Singapore 768078 **Andrew William GILLETT Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive

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Australia 2153

Bella Vista, New South Wales

Executed for and on behalf of ResMed Asia Pte. Ltd.
Signature of Authorised Person
Chin Wee Chew Name of Authorised Person
Singapore Office held
Date:
Executed for and on behalf of ResMed Pty Ltd
Signature of Authorised Person
Robert Zalud Name of Authorised Person
<b>Australia</b> Office held

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Ltd., 3 Tuas Avenue 2
Singapore 639443

Date Signed

Robin YEW	
Address: c/o ResMed Asia Pte. Ltd., 3 Tuas Avenue 2 Singapore 639443	Date Signed
DocuSigned by:	21-Feb-2022
Han Seong CHEW	21-Feb-2022
Address: c/o ResMed Asia Pte. Ltd., 3 Tuas Avenue 2 Singapore 639443	Date Signed
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Executed for and on behalf of ResMed Asia Pte. Ltd.
Signature of Authorised Person
<b>Chin Wee Chew</b> Name of Authorised Person
Singapore Office held
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Date Signed

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### **Date Signed Vinay MANJUNATH** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 Nigel Paul GREIG **Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 **Albert Jack Greenwood WOFFENDEN Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 **Date Signed Chuan Foong LEE** Address: c/o ResMed Asia Pte. Ltd. 3 Tuas Avenue 2 Singapore 639443 Muhammad Adil BIN ABDUL HALIM **Date Signed** Address: 25 Canberra Drive, #04-52 Singapore 768078 **Andrew William GILLETT Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales

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Australia 2153

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Signature of Authorised Person
Chin Wee Chew Name of Authorised Person
Singapore Office held
Date:
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**EFFECTIVE DATE: DECEMBER 14, 2021** 

IN WITNESS WHEREOF, we have hereunto set our hands on the date indicated below.

Deng Siong LEE Address: c/o ResMed Asia Pte. Ltd., 3 Tuas Avenue 2 Singapore 639443

Date Signed

### **Robin YEW** Address: c/o ResMed Asia Pte. **Date Signed** Ltd., 3 Tuas Avenue 2 Singapore 639443 **Han Seong CHEW** Address: c/o ResMed Asia Pte. **Date Signed** Ltd., 3 Tuas Avenue 2 Singapore 639443 Teong Hong CHUAH **Date Signed** Address: c/o ResMed Asia Pte. Ltd. 3 Tuas Avenue 2 Singapore 639443 DocuSigned by: 1 Shannon Day 1 16-Jan-2022 **Date Signed Shannon DAY** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 **Christopher Daniel PARKER Date Signed** Address: c/o ResMed Pty Ltd

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1 Elizabeth Macarthur Drive Bella Vista, New South Wales

**Date Signed Vinay MANJUNATH** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 Nigel Paul GREIG **Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 **Albert Jack Greenwood WOFFENDEN Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 **Date Signed Chuan Foong LEE** Address: c/o ResMed Asia Pte. Ltd. 3 Tuas Avenue 2 Singapore 639443 Muhammad Adil BIN ABDUL HALIM **Date Signed** Address: 25 Canberra Drive, #04-52 Singapore 768078 **Andrew William GILLETT Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive

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Australia 2153

Bella Vista, New South Wales

Executed for and on behalf of ResMed Asia Pte. Ltd.
Signature of Authorised Person
Chin Wee Chew Name of Authorised Person
Singapore Office held
Date:
Executed for and on behalf of ResMed Pty Ltd
Signature of Authorised Person
<b>Robert Zalud</b> Name of Authorised Person
<b>Australia</b> Office held

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/ Vinay ManyUnatth / 13-Jan-2022 -554F27EE84FF436.. Vinay MANJUNATH **Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 **Nigel Paul GREIG Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 **Albert Jack Greenwood WOFFENDEN Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 **Chuan Foong LEE Date Signed** Address: c/o ResMed Asia Pte. Ltd. 3 Tuas Avenue 2 Singapore 639443 Muhammad Adil BIN ABDUL HALIM **Date Signed** 

Andrew William GILLETT

Singapore 768078

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Address: 25 Canberra Drive, #04-52

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Signature of Authorised Person
Chin Wee Chew Name of Authorised Person
Singapore Office held
Date:
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Australia 2153

**Andrew William GILLETT** 

Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales

> PATENT REEL: 061357 FRAME: 0744

**Date Signed** 

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Signature of Authorised Person
Chin Wee Chew Name of Authorised Person
Singapore Office held
Date:
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Date Signed

### **Robin YEW** Address: c/o ResMed Asia Pte. **Date Signed** Ltd., 3 Tuas Avenue 2 Singapore 639443 **Han Seong CHEW** Address: c/o ResMed Asia Pte. **Date Signed** Ltd., 3 Tuas Avenue 2 Singapore 639443 Teong Hong CHUAH **Date Signed** Address: c/o ResMed Asia Pte. Ltd. 3 Tuas Avenue 2 Singapore 639443 **Date Signed Shannon DAY** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 **Christopher Daniel PARKER Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153

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#### **Vinay MANJUNATH**

Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 **Date Signed** 

#### Nigel Paul GREIG

Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 Date Signed

#### **Albert Jack Greenwood WOFFENDEN**

Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 Date Signed

#### Chuan Foong LEE

Address: c/o ResMed Asia Pte. Ltd. 3 Tuas Avenue 2 Singapore 639443 **Date Signed** 

Docusigned by.

4AD3758E3F0645C

21-Jan-2022

#### **Muhammad Adil BIN ABDUL HALIM**

Address: 25 Canberra Drive, #04-52

Singapore 768078

**Date Signed** 

#### **Andrew William GILLETT**

Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 **Date Signed** 

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Executed for and on behalf of ResMed Asia Pte. Ltd.
Signature of Authorised Person
Chin Wee Chew Name of Authorised Person
Singapore Office held
Date:
Executed for and on behalf of ResMed Pty Ltd
Signature of Authorised Person
<b>Robert Zalud</b> Name of Authorised Person
<b>Australia</b> Office held

# CONFIRMATION OF ASSIGNMENT Inventor(s) to ResMed Asia Pte. Ltd. And ResMed Pty Ltd

WHEREAS, I/we, Deng Siong Lee, Robin Yew, Han Seong Chew, Teong Hong Chuah, Shannon Day, Christopher Daniel Parker, Vinay Manjunath, Nigel Paul Greig, Albert Jack Greenwood Woffenden, Chuan Foong Lee, Muhammad Adil Bin Abdul Halim, and Andrew William Gillett, an inventor, joint inventor, inventors or joint inventors (collectively hereinafter "Inventor") have made certain new and useful inventions relating to [ORO-PILLOW CUSHION ASSEMBLY], (hereinafter "Inventive-Subject matter") which is described in and for which application has been made as follows:

 U.S. Utility Application filed on December 14, 2021 and designated as Application No. 17/550,168.

WHEREAS, ResMed Asia Pte. Ltd., a company incorporated in Singapore, and ResMed Pty Ltd, a company incorporated in Australia (hereinafter "Assignees"), whose postal address is 3 Tuas Avenue 2 Singapore 639443, and 1 Elizabeth Macarthur Drive, Bella Vista, New South Wales, Australia 2153, respectfully, is desirous of acquiring the entire right, title and interest in and to said Inventive Subject-Matter, including without limitation said application(s), for every jurisdiction, including without limitation the United States of America and all other countries, and any benefits of or to be obtained therefrom:

NOW THEREFORE, in consideration of the sum of one dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, and on the Effective Date herein, Inventor has sold, assigned, and set over and/or to any extent not previously, by these presents does hereby sell, assign and set over unto Assignee and Assignee's legal representatives, successors and assigns, Inventor's entire right, title and interest in and to said Inventive Subject-Matter for every jurisdiction, including without limitation the United States of America and all other countries, said application(s) and any benefits of or to be obtained therefrom, including without limitation any continuation, including continuation-in-part, or divisional application, renewal or substitute thereof, international, foreign and regional applications corresponding or claiming priority thereto pursuant to any law or treaty, including the right to claim such priority or benefit, and the Letters Patent, both foreign and domestic, that may or shall issue thereon, or any reissue or re-examination thereof, and Inventor does hereby authorize and request the U.S. Commissioner of Patents and any other country's

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Commissioner of Patents to issue said Letters Patent to the above-mentioned Assignee, consistent with the terms of this Assignment.

UPON SAID CONSIDERATION, Inventor hereby covenants and agrees with Assignee that Inventor has not and will not execute any writing or do any act whatsoever conflicting with these presents, and that Inventor will, at any time upon request, without further or additional consideration, but at the expense of Assignee, execute such additional assignments and other writings and do such additional acts as Assignee may deem necessary or desirable to perfect Assignee's or Assignee's assign's enjoyment of this grant, and render all necessary assistance in making application for and obtaining original, continuation, including continuation-in-part, or divisional application, renewal, substitute, reissued, re-examined or extended Letters Patent of the United States, or of any and all other countries, on said Inventive Subject-Matter, and in enforcing any rights or chose in action accruing as a result of such applications or patents, by giving testimony in any proceedings or transactions involving such applications or patents, and by executing preliminary statements and other affidavits, it being understood that the foregoing covenant and agreement shall bind, and inure to the benefit of, the assigns and legal representatives of all parties.

And I/we do hereby authorize attorneys for Assignee to insert on this confirmation of assignment any additional filing date and application number and/or patent number of the aforementioned application(s) when known.

This Confirmation of Assignment may be executed in any number of counterparts and the executed counterparts together constitute an original.

**EFFECTIVE DATE: DECEMBER 14, 2021** 

IN WITNESS WHEREOF, we have hereunto set our hands on the date indicated below.

Deng Siong LEE Address: c/o ResMed Asia Pte. Ltd., 3 Tuas Avenue 2 Singapore 639443

Date Signed

Robin YEW		
Address: c/o ResMed Asia Pte. Ltd., 3 Tuas Avenue 2 Singapore 639443		Date Signed
Han Seong CHEW Address: c/o ResMed Asia Pte. Ltd., 3 Tuas Avenue 2 Singapore 639443		Date Signed
Teong Hong CHUAH Address: c/o ResMed Asia Pte. 3 Tuas Avenue 2 Singapore 639443	Ltd.	Date Signed
Shannon DAY Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153		Date Signed
Christopher Daniel PARKER Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153		Date Signed

**Vinay MANJUNATH** 

Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153

**Date Signed** 

**Nigel Paul GREIG** 

Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153

**Date Signed** 

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Australia 2153

**Date Signed** 

**Chuan Foong LEE** 

Address: c/o ResMed Asia Pte. Ltd. 3 Tuas Avenue 2

Singapore 639443

**Date Signed** 

Muhammad Adil BIN ABDUL HALIM

Address: 25 Canberra Drive, #04-52

Singapore 768078

**Date Signed** 

-DocuSigned by:

1 Andrew William Gillett 1 --- ACA5FFB848A641E..

13-Jan-2022

**Andrew William GILLETT** 

Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales

Australia 2153

**Date Signed** 

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Executed for and on behalf of ResMed Asia Pte. Ltd.
Signature of Authorised Person
<b>Chin Wee Chew</b> Name of Authorised Person
Singapore Office held
Date:
Executed for and on behalf of ResMed Pty Ltd
Signature of Authorised Person
Robert Zalud Name of Authorised Person
<b>Australia</b> Office held

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WHEREAS, I/we, Deng Siong Lee, Robin Yew, Han Seong Chew, Teong Hong Chuah, Shannon Day, Christopher Daniel Parker, Vinay Manjunath, Nigel Paul Greig, Albert Jack Greenwood Woffenden, Chuan Foong Lee, Muhammad Adil Bin Abdul Halim, and Andrew William Gillett, an inventor, joint inventor, inventors or joint inventors (collectively hereinafter "Inventor") have made certain new and useful inventions relating to [ORO-PILLOW CUSHION ASSEMBLY], (hereinafter "Inventive-Subject matter") which is described in and for which application has been made as follows:

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NOW THEREFORE, in consideration of the sum of one dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, and on the Effective Date herein, Inventor has sold, assigned, and set over and/or to any extent not previously, by these presents does hereby sell, assign and set over unto Assignee and Assignee's legal representatives, successors and assigns, Inventor's entire right, title and interest in and to said Inventive Subject-Matter for every jurisdiction, including without limitation the United States of America and all other countries, said application(s) and any benefits of or to be obtained therefrom, including without limitation any continuation, including continuation-in-part, or divisional application, renewal or substitute thereof, international, foreign and regional applications corresponding or claiming priority thereto pursuant to any law or treaty, including the right to claim such priority or benefit, and the Letters Patent, both foreign and domestic, that may or shall issue thereon, or any reissue or re-examination thereof, and Inventor does hereby authorize and request the U.S. Commissioner of Patents and any other country's

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Commissioner of Patents to issue said Letters Patent to the above-mentioned Assignee, consistent with the terms of this Assignment.

UPON SAID CONSIDERATION, Inventor hereby covenants and agrees with Assignee that Inventor has not and will not execute any writing or do any act whatsoever conflicting with these presents, and that Inventor will, at any time upon request, without further or additional consideration, but at the expense of Assignee, execute such additional assignments and other writings and do such additional acts as Assignee may deem necessary or desirable to perfect Assignee's or Assignee's assign's enjoyment of this grant, and render all necessary assistance in making application for and obtaining original, continuation, including continuation-in-part, or divisional application, renewal, substitute, reissued, re-examined or extended Letters Patent of the United States, or of any and all other countries, on said Inventive Subject-Matter, and in enforcing any rights or chose in action accruing as a result of such applications or patents, by giving testimony in any proceedings or transactions involving such applications or patents, and by executing preliminary statements and other affidavits, it being understood that the foregoing covenant and agreement shall bind, and inure to the benefit of, the assigns and legal representatives of all parties.

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Date Signed

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**Vinay MANJUNATH Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 Nigel Paul GREIG **Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 **Albert Jack Greenwood WOFFENDEN Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 **Date Signed Chuan Foong LEE** Address: c/o ResMed Asia Pte. Ltd. 3 Tuas Avenue 2 Singapore 639443 Muhammad Adil BIN ABDUL HALIM **Date Signed** Address: 25 Canberra Drive, #04-52 Singapore 768078 **Andrew William GILLETT Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales

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Australia 2153

ResMed Asia Pte. Ltd.
Docusigned by:  / Lin We LHEW /  94F0F4A9CF42444  Signature of Authorised Person
Chin Wee Chew Name of Authorised Person
Singapore Office held 08-Aug-2022 Date:
Executed for and on behalf of ResMed Pty Ltd
Signature of Authorised Person
Robert Zalud Name of Authorised Person
Australia Office held
Date:

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### **Date Signed Vinay MANJUNATH** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 Nigel Paul GREIG **Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 **Albert Jack Greenwood WOFFENDEN Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive Bella Vista, New South Wales Australia 2153 **Date Signed Chuan Foong LEE** Address: c/o ResMed Asia Pte. Ltd. 3 Tuas Avenue 2 Singapore 639443 Muhammad Adil BIN ABDUL HALIM **Date Signed** Address: 25 Canberra Drive, #04-52 Singapore 768078 **Andrew William GILLETT Date Signed** Address: c/o ResMed Pty Ltd 1 Elizabeth Macarthur Drive

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Australia 2153

Bella Vista, New South Wales

Executed for and on behalf of ResMed Asia Pte. Ltd.
Signature of Authorised Person
Chin Wee Chew Name of Authorised Person
Singapore Office held
Date:
Executed for and on behalf of ResMed Pty Ltd  / Kohut Elli) /
Signature of Authorised Person
Robert Zalud Name of Authorised Person
<b>Australia</b> Office held
08-Aug-2022

**RECORDED: 08/31/2022**